# **COMPACT AI Rugged Vehicle Series**

Computer Vision Edge Unit with NVIDIA Jetson AGX Xavier



# **RPC/COMPACT RSL A3 (E2)**

This fanless RPC COMPACT-A3 is based on the NVIDIA Jetson AGX Xavier processor module and offers a wide range of highly integrated interface options.

The ultra rugged and uncompromising design allows the use in the most demanding AI applications on mobile systems as well as in outdoor applications with harsh environmental conditions and guarantees long-term availability.

- 24/7 continuous operation
- Extended AI computing
- Wide temperature range
- Sealed housing with IP67, IP69 protection
- Shock and vibration resistant





## **Product Highlights**

Ultra rugged
Sealed housing, protection class IP67 & IP69
Maintenance free
Power Ignition controller
No moving parts / passively cooled
Pressure equalization membrane
Resistance to chemicals
Long term availability (fixed BOM)

### **Product Features**

AGX Xavier or AGX Xavier Industrial
512-core NVIDIA Volta™ GPU
8-Core ARM v8.2 64-bit NVIDIA Carmel CPU
32GB 256-Bit LPDDR4x RAM soldered on board
NVMe M.2 2280 storage options
Ethernet, RS232, Digital I/O, USB 3.1, CAN-FD
SAE J1939 support
Rugged M12 connectors

### **Industries**

Agriculture
Construction
Transportation
Off-Highway Vehicles
Heavy Industry
Autonomous Mobile Robots (AMRs)
Oudoor applications

		Order Code	RPC/RSLA3K22-M134S <sup>1</sup>	RPC/RSLA3K22-N132
Processor module / Performance				
NVIDIA Jetson AGX Xavier   <b>32GB RAM</b>   512-core NVIDIA Volta™ GF	PU with 64 Tensor Cores		•	•
B-Core ARM v8.2 64-bit NVIDIA Carmel CPU			•	•
Al Performance			32 TOPs	32 TOPs
JVIDIA Jetson AGX Xavier   <b>64GB RAM</b>   512-core NVIDIA Volta™ GF	PU with 64 Tensor Cores		on request	on request
NVIDIA Jetson AGX <b>Xavier Industrial</b> 512-Core NVIDIA Volta™ GPU (ECC) with 64 Tensor Cores			on request	on request
Memory / Storage	(225)			
Data L3 Cache Size			4MB	4MB
256-Bit LPDDR4x RAM soldered on board			32GB	32GB
MMC 5.1 Flash Storage on board			32GB	32GB
nicroSD Card socket			1	1
1.2 2280 Key M socket (for NVMe SSD) <sup>2</sup>			1	1
eatures				
nertial measurement unit (IMU) STMicroelectronics ISM330DHCXTR			•	•
eal time clock (RTC) with battery backup Renata CR2477 (950 mAh)			•	•
Communication Interfaces				•
Display output behind the back service cover	(1) Chandand LIDMI compositor)		LIDMI 2.0	LIDMI 2.0
nternal USB version 2.0 OTG behind the back service cover	(1x Standard HDMI connector)		HDMI 2.0	HDMI 2.0
ISB version 2.0 behind the back service cover	(micro USB Type AB )		<u> </u>	I
	(Type A )		2	2
thernet 10/100/1000 Mbit BASE-T	(M12 female x-coded)		2	2
AN 2.0A / CAN 2.0B (active/passive), CAN FD supported, isolated	(M12 female a-coded)		2	2
Digital I/O's, 12/24VDC <sup>1</sup>	(M12 male a-coded)		4 in & 2 out	4 in & 2 out
erial RS232 RX, TX, RTS, CTS, GND	(M12 male a-coded)		1	1
SB version 3.1 (5Gbit/s)	(Type A, IP67)		1	1
1ini PCle socket <sup>2</sup>			1	1
PS Input 1, 3.3V (LVCMOS), connected to Xavier GPIO	(1x SMA)		on request	on request
lower over Ethernet - IEEE802.3at 10/100/1000Mbit 1, taller housing: h103r	nm (M12 female x-coded)		on request	on request
MSL2 camera inputs 1, taller housing: h103mm	(4x/8x FAKRA-Z)		on request	on request
Vireless Connectivity				
Cellular 4G Module (LTE/UMTS/GSM) with built-in GNSS 6, Sierra Wireles	s EM7590 (Dual nano SIM support)		3x SMA	on request
Vireless LAN (Wi-Fi 5) 802.11a/b/g/n/ac dual-band 2x2 MIMO & Bl	luetooth 5.1 Intel Wireless-AC 9260		2x RP-SMA	on request
Cellular 5G module (4G/3G fallback) with GNSS			on request	on request
Vireless LAN (Wi-Fi 6) 802.11ax/ac/a/b/g/n dual-band 2x2 MIMO			on request	on request
ligh Accuracy (RTK) GNSS positioning module with optional heading	g SUDDOrt u-blox ZED F9R / F9P		on request	on request
echnical Data	0 24FF 31.		on request	on request
Dimensions mm (housing, excl. mounting)			w250 x h75 x d170	w250 x h75 x d170
let weight in gram			~3050	~3000
Ion isolated input voltage, with Ignition controller reverse polarity protected	(M12 5P male a-coded)		9 45VDC	9 45VDC
ower consumption <sup>3</sup>	(W12 31 Maie a coaca)		depends on power mo	
invironmental Conditions			depends on power me	de (1511, 5011, 1111 till)
Operating temperature <sup>3</sup>			−25°C +65°C	−25°C +65°C
torage temperature			−25°C +80°C	−25°C +80°C
<u> </u>			IP67 / IP69	IP67 / IP69
ngress protection standard according to EN60529 (ISO 20653) conformal coating <sup>4</sup>			· · · · · · · · · · · · · · · · · · ·	
oad vehicles, UN/ECE R10 (E-mark) <sup>5</sup>			on request	on request on request
hock ISO 15003 / EN60068-2-64 (designed to meet)			on request	on request •
, , ,			•	•
ibration ISO 15003 / EN60068-2-64 (designed to meet)			ENICEO72 / FNICEO75	
MI-Conformity			EN55032 / EN55035	EN55032 / EN5503
afety (designed to meet)			EN62368-1	EN62368-1
Radio and Telecommunication (designed to meet)  ATBF @ 25°C ambient according to Telcordia SR-332, Environment GB, excluding battery			RED	RED
ATIBLE @ 25°C amplient according to recording serious, Environment als, excluding battery			~300 000h	~400 000

<sup>&</sup>lt;sup>1</sup> Please contact factory for minimum order quantities

Product specifications subject to change without notice. | All data is for information purposes only and not guaranteed for legal purposes. Information in this data sheet has been carefully checked and is believed to be accurate. However, no responsibility is assumed for inaccuracies. Please refer to the user documentation for additional product specification.

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<sup>&</sup>lt;sup>2</sup> Internal connector

<sup>&</sup>lt;sup>3</sup> Depending on installation situation, power mode and interface connection. See user documentation.

<sup>&</sup>lt;sup>4</sup>On all possible components (excl. NVIDIA Xavier Module, connectors and wireless devices)

<sup>&</sup>lt;sup>5</sup>UN/ECE-R10 is the type-approval test for European automotive electronics. It includes a variety of testing including RF immunity and emissions, transient immunity and emissions.

The first versions of this product, featured the Sierra Wireless EM7455 LTE module (RPC/RSLA3K22-M132S), this has been switched to the EM7590 for mass production, due to the EM7455 being EOL.